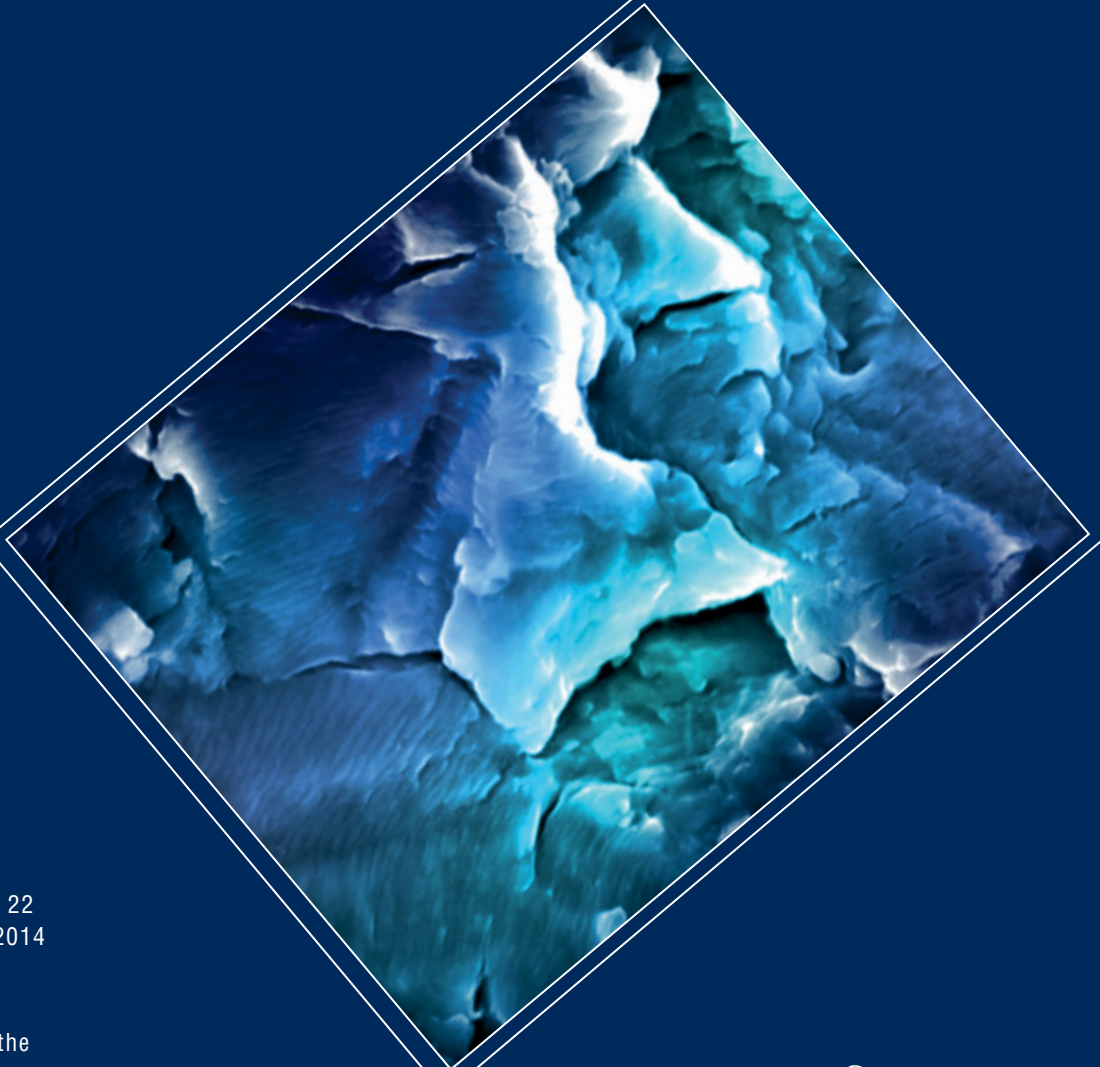




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Cover: FIG. 4(g). SEM picture for the crack propagation regions of the specimens under the rotary bending tests. [D. Shi, J. Huang, Y. Luo, X. Yang, H. Yu, and P. Zhao: Experimental investigation on HCF strength affected by predamage from LCF of a near alpha titanium alloy. p. 2748].

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